

## ABSTRACT OF DISCLOSURE

In a bonding method in which two display panels 7A, 7B are held by the two panel holding portions 31a, 31b provided on the panel support table 31 positioned by the XYθ table 30 so as to position the first pressure bonding head 25A and the second pressure bonding head 25B for conducting pressure bonding individually, according to the result of positional detection of the camera 37 and the recognizing portion 65, the display panel 7A is positioned to the first pressure bonding head and an object of pressure bonding is bonded by pressure. In this pressure bonding step, under the condition that a state of holding the display panel 7A is released, the display panel 7B is positioned to the second pressure bonding head 25B.

[Selected Drawing] Fig. 4